

Features

- Standard 0402 footprint
- Fast Time-to-Trip (TTT) to protect in overcurrent events
- Excellent solderability with ENIG terminal
- Symmetrical design and low profile of 0.6 mm
- RoHS compliant* and halogen free**
- Agency recognition: c UL us, TÜV
- TÜV certifications cover IEC 62319-1, IEC 60738-1, and IEC 60730-1:2013, encompassing clause 15, clause 17, and Annex J.

MF-ASML/X Series - Low Ohmic PTC Resettable Fuses

Electrical Characteristics

Model	V max.	I max.	I_{hold}	I_{trip}	Resistance		Max. Time To Trip		Tripped Power Dissipation	Agency Recognition	
			at 23 °C		at 23 °C Ohms		at 23 °C		Watts at 23 °C	cUL	TÜV
	Volts	Amps	Amps		R_{min}	R_{1max}[1]	Amps	Seconds	Typ.	E174545	R50391579
MF-ASML010/6	6	50	0.10	0.3	0.15	3.0	0.5	1.0	0.5	✓	✓
MF-ASML020/6	6	50	0.20	0.5	0.10	1.6	1.0	1.0	0.5	✓	✓
MF-ASML035/6	6	50	0.35	0.7	0.05	0.85	8.0	0.1	0.5	✓	✓
MF-ASML050/6	6	50	0.50	1.0	0.04	0.50	8.0	0.1	0.5	✓	✓
MF-ASML075/6	6	50	0.75	1.5	0.025	0.25	8.0	0.1	0.5	✓	✓

Note 1. R_{1max}: measured 1 hour post reflow.

Environmental Characteristics

Item		Condition	Criteria
Operating Temperature		-40 °C to +85 °C	
Storage Condition	Before Opening	+40 °C max. / 70 % RH max.	
	After Opening	+40 °C max. / 10 % RH max.	
Floor Condition After Opening		Consumption within 4 weeks at floor condition +30 °C max. / 60 % RH max.	
Passive Aging		+85 °C, 1000 hours	±10 % typical resistance change
Humidity Aging		+85 °C, 85 % R.H. 24 hours	±30 % typical resistance change
Thermal Shock		-40 °C to +85 °C, 20 times	±30 % typical resistance change
Vibration		MIL-STD-883C, Method 2007.1 Condition A	No change ($R_{min} < R < R_{1max}$)
Moisture Sensitivity Level (MSL)		See Note	
ESD Classification		Class 6 (per AEC-Q200-2, HBM)	

Additional Information

Click these links for more information:

PRODUCT SELECTOR | TECHNICAL LIBRARY | INVENTORY | SAMPLES | CONTACT

CALIFORNIA WARNING: Can expose you to lead, a carcinogen and reproductive toxicant.
See www.P65Warnings.ca.gov

* RoHS Directive 2015/863, Mar 31, 2015 and Annex.
** Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less.

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Test Procedures and Requirements

Item	Test Condition	Accept/Reject Criteria
Visual/Mechanical	Verify dimensions and materials	Per MF physical description
Resistance	In still air @ 23 °C	$R_{min} \le R \le R_{max}$
Time to Trip	At specified current, V_{max}, 23 °C, still air	T ≤ max. time to trip (seconds)
Hold Current	30 min. at I_{hold}, still air	No trip
Trip Cycle Life	V_{max}, I_{max}, 100 cycles	No arcing or burning
Trip Endurance	V_{max}, I_{max}, 48 hours	No arcing or burning
Solderability	245 °C ±5 °C, 5 seconds	95 % min. coverage

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Applications

- Thermal protection for wearables, Li-ion & polymer battery packs
- PC motherboards – Plug & Play protection
- Mobile phones – battery & charging protection
- USB port protection
- Game console port protection
- Electronic reading devices and digital cameras

MF-ASML/X Series - Low Ohmic PTC Resettable Fuses

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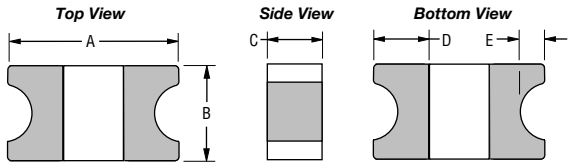
Thermal Derating Table - I_{hold} (Amps)

Model	Ambient Operating Temperature								
	-40 °C	-20 °C	0 °C	23 °C	40 °C	50 °C	60 °C	70 °C	85 °C
MF-ASML010/6	0.16	0.14	0.12	0.10	0.08	0.07	0.06	0.05	0.04
MF-ASML020/6	0.32	0.28	0.24	0.20	0.16	0.14	0.12	0.10	0.08
MF-ASML035/6	0.56	0.49	0.42	0.35	0.28	0.24	0.21	0.17	0.14
MF-ASML050/6	0.80	0.70	0.60	0.50	0.40	0.35	0.30	0.25	0.20
MF-ASML075/6	1.20	1.05	0.90	0.75	0.60	0.52	0.45	0.37	0.30

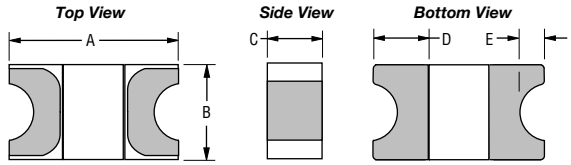
Product Dimensions

Model	Style	A		B		C		D	E
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
MF-ASML010/6	1	0.85 (0.033)	1.15 (0.045)	0.35 (0.014)	0.65 (0.026)	0.20 (0.008)	0.60 (0.024)	0.10 (0.004)	0.03 (0.0012)
MF-ASML020/6	2								
MF-ASML035/6	2								
MF-ASML050/6	2								
MF-ASML075/6	2								

Style 1

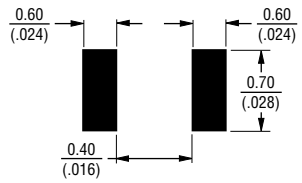


Style 2



Terminal material:
Electroless Ni under immersion Gold (ENIG)

Recommended Pad Layout

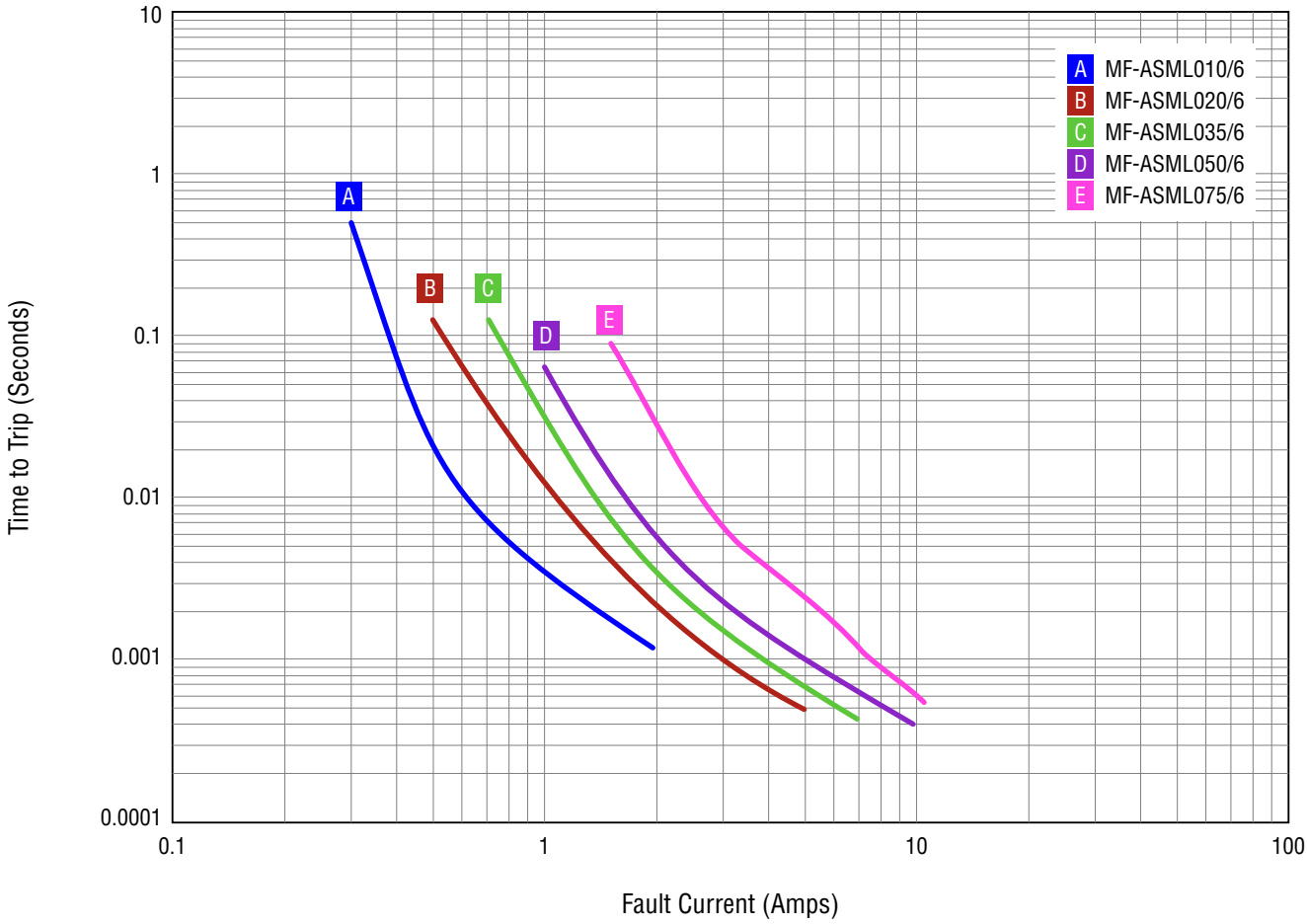


DIMENSIONS: MM (INCHES)

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Typical Time to Trip at 23 °C

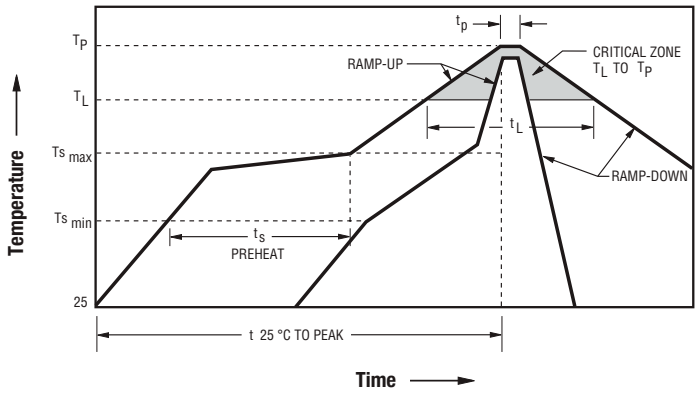


The Time to Trip curves represent typical performance of a device in a simulated application environment.
Actual performance in specific customer applications may differ from these values due to the influence of other variables

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Solder Reflow Recommendations



Notes:

- MF-ASML/X models are intended for reflow soldering (including, but not limited to heating plate, hot air, IR, nitrogen, and vapor phase).
- Wave soldering is permissible only if the device is on the top of the PCB, opposite the heat source.
- Hand soldering is not recommended for these devices.
- All temperatures refer to the topside of the device, measured on the device body surface.
- If reflow temperatures exceed the recommended profile, devices may not meet the published specifications.
- Compatible with Pb and Pb-free solder reflow profiles.
- Excess solder may cause a short circuit.
- Please refer to the Multifuse® Polymer PTC Resettable Fuse Soldering Recommendations document for more details.

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (Ts_{max} to T_p)	3 °C / second max.
PREHEAT: Temperature Min. (Ts_{min}) Temperature Max. (Ts_{max}) Time (Ts_{min} to Ts_{max}) (ts)	 150 °C 200 °C 60~180 seconds
TIME MAINTAINED ABOVE: Temperature (T_L) Time (t_L)	 217 °C 60~150 seconds
Peak Temperature (T_p)	260 °C
Time within 5 °C of Actual Peak Temperature (t_p)	20~40 seconds
Ramp-Down Rate	6 °C / second max.
Time 25 °C to Peak Temperature	8 minutes max.

How to Order

MF - ASML 050 / 6 - 2

Multifuse® Product Designator

Series
ASML = 0402 Low Ohmic Surface Mount Component

Hold Current, I_{hold}
010 - 075 (0.10 Amps - 0.75 Amps)

Maximum Voltage, V_{max}
6 = 6 Volts

Packaging
-2 = Tape and Reel Packaged per EIA-481

Typical Part Marking

No marking.

Packaging Quantity

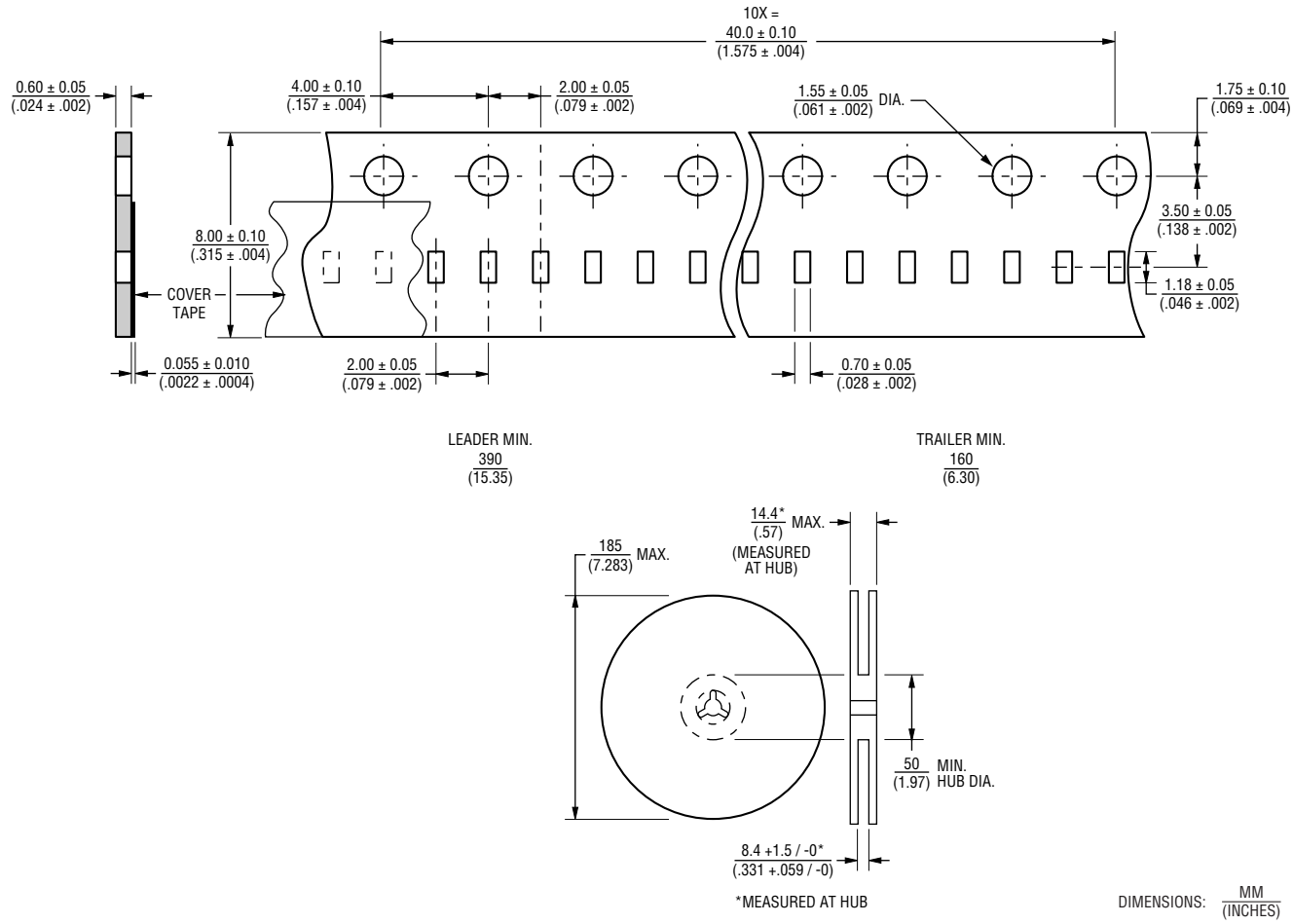
10,000 pcs. per reel

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Packaging Specifications

MF-ASML/X Series per EIA-481



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Application Notice

- Users are responsible for independent and adequate evaluation of Bourns® Multifuse® Polymer PTC devices in the user's application, including the PPTC device characteristics stated in the applicable data sheet.
- Polymer PTC devices must not be allowed to operate beyond their stated maximum ratings. Operation in excess of such maximum ratings could result in damage to the PTC device and possibly lead to electrical arcing and/or fire. Circuits with inductance may generate a voltage above the rated voltage of the polymer PTC device and should be thoroughly evaluated within the user's application during the PTC selection and qualification process.
- Polymer PTC devices are intended to protect against adverse effects of temporary overcurrent or overtemperature conditions up to rated limits and are not intended to serve as protective devices where overcurrent or overvoltage conditions are expected to be repetitive or prolonged.
- In normal operation, polymer PTC devices experience thermal expansion under fault conditions. Thus, a polymer PTC device must be protected against mechanical stress, and must be given adequate clearance within the user's application to accommodate such thermal expansion. Rigid potting materials or fixed housings or coverings that do not provide adequate clearance should be thoroughly examined and tested by the user, as they may result in the malfunction of polymer PTC devices if the thermal expansion is inhibited.
- Exposure to lubricants, silicon-based oils, solvents, gels, electrolytes, acids, and other related or similar materials may adversely affect the performance of polymer PTC devices.
- Aggressive solvents may adversely affect the performance of polymer PTC devices. Conformal coating, encapsulating, potting, molding, and sealing materials may contain aggressive solvents including but not limited to xylene and toluene, which are known to cause adverse effects on the performance of polymer PTCs. Such aggressive solvents must be thoroughly cured or baked to ensure their complete removal from polymer PTCs to minimize the possible adverse effect on the device.
- Recommended storage conditions should be followed at all times. Such conditions can be found on the applicable data sheet and on the Multifuse® Polymer PTC Moisture/Reflow Sensitivity Classification (MSL) note: https://www.bourns.com/docs/RoHS-MSL/msl_mf.pdf

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Bourns® products are not recommended, authorized or intended for use in applications where failure or malfunction may result in personal injury, death, or severe property or environmental damage, such as without limitation nuclear, life-critical medical and certain automotive and aviation applications. Except as set forth in the bullet points below or unless expressly and specifically approved in writing on a case-by-case basis by an authorized Bourns' representative, use of any Bourns® products in such unauthorized high-risk applications is at the user's sole risk.

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- Bourns expressly identifies Bourns® standard products that are suitable for use in the typical aviation applications/systems requiring System Design Assurance Level (RTCA DO-254 DAL) of C, D or E in its publication entitled "Bourns Civilian Aerospace/Aviation Grade Component Guide." Bourns does not test its products for compliance with United States Federal Aviation Administration standards or any other generally equivalent governmental organization standard applicable to products designed or manufactured for use in aviation applications. Use of Bourns® standard components in aviation applications associated with RTCA DO-254 DAL A or B without proper approval noted above shall be at the user's sole risk.

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